

Ultra-small 28.5 m Ω , 1.0 A Load Switch with Discharge

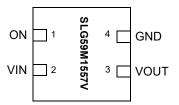
General Description

The SLG59M1557V is designed for load switching applications with ultra low quiescent current. The part comes with one 28.5 m Ω 1.0 A rated P-channel MOSFET controlled by a single ON control pin. The product is packaged in an ultra-small 1.0 x 1.0 mm package.

Features

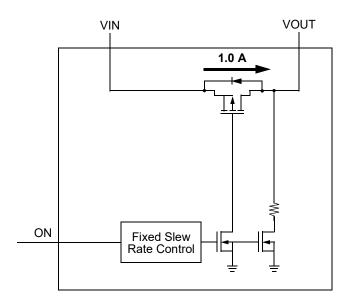
- One 1.0 A MOSFET
- · Ultra Low Quiescent Current
- Low RDSON
 - 28.5 mΩ @ 5.0 V
 - 36.4 mΩ @ 3.3 V
 - 44.3 mΩ @ 2.5 V
 - 60.8 mΩ @ 1.8 V
 - 77.6 m Ω @ 1.5 V
- V_{IN} = 1.5 V to 5.5 V
- Integrated Discharge Resistor
- Pb-Free / Halogen-Free / RoHS compliant
- STDFN 4L, 1.0 x 1.0 x 0.55 mm

Pin Configuration



4-pin STDFN (Top View)

Block Diagram





SLG59M1557V

Pin Description

Pin#	Pin Name	Туре	Pin Description
1	ON	Input	Turns on MOSFET.
2	VIN	MOSFET	Power MOSFET input
3	VOUT	MOSFET	Power MOSFET output
4	GND	GND	Ground

Ordering Information

Part Number	Туре	Production Flow
SLG59M1557V	STDFN 4L	Industrial, -40 °C to 85 °C
SLG59M1557VTR	STDFN 4L (Tape and Reel)	Industrial, -40 °C to 85 °C

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Absolute Maximum Ratings

Parameter	Description	Conditions	Min.	Тур.	Max.	Unit
V _{IN}	Power Supply				6	V
T _S	Storage Temperature		-65		140	°C
ESD _{HBM}	ESD Protection	Human Body Model	2000			V
W _{DIS}	Package Power Dissipation			-	0.5	W
MOSFET IDS _{PK}	Peak Current from Drain to Source	For no more than 1 ms with 1% duty cycle			1.5	Α

Note: Stresses greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

Electrical Characteristics

 T_A = -40 °C to 85 °C (unless otherwise stated)

Parameter	1 1 1 1 1		Min.	Тур.	Max.	Unit
V _{IN}	Power Supply Voltage	-40 °C to 85 °C	1.5		5.5	V
	Power Supply Current (PIN 2)	when OFF, V _{IN} = 5.5 V, No load		0.02	1	μΑ
I _{DD}	Power Supply Current (PIN 2)	when ON = V _{IN} , No load				μΑ
I _{ON_LKG}	ON Pin Input Leakage				0.1	μΑ
'ON_LKG		@ 5.5 V, 100 mA		28.5	32.0	mΩ
	0 5 0	@ 3.3 V, 100 mA		36.4	40.0	mΩ
RDS _{ON}	Static Drain to Source ON Resistance @ T _A 25°C	@ 2.5 V, 100 mA		44.3	49.0	mΩ
	CTT TOOLSTAINS & TA 20 0	@ 1.8 V, 100 mA		60.8	65.0	mΩ
		@ 1.5 V, 100 mA		77.6	82.0	mΩ
RDS _{ON}		@ 5.5 V, 100 mA		34.0	36.0	mΩ
		@ 3.3 V, 100 mA		43.8	46.0	mΩ
	Static Drain to Source ON Resistance @ T _A 85°C	@ 2.5 V, 100 mA		53.3	56.0	mΩ
	CN resistance & 1 _A co c	@ 1.8 V, 100 mA		72.2	76.0	mΩ
		@ 1.5 V, 100 mA		90.7	94.0	mΩ
IDS	Operating Current	V _{IN} = 1.5 V to 5.5 V			1.0	Α
		50% ON to Ramp Begin V_{IN} = 5 V, VOUT_Cap = 0.1 μF, R_L = 10 Ω		15	27	μs
T _{ON_Delay}	ON pin Delay Time	50% ON to Ramp Begin V_{IN} = 3.3 V, VOUT_Cap = 0.1 μF, R_L = 10 Ω	17	31	40	μs
		50% ON to Ramp Begin V_{IN} = 1.5 V, VOUT_Cap = 0.1 μF, R_L = 10 Ω	44	69	96	μs
T _{Total_ON}		50% ON to 90% VOUT V_{IN} = 5 V, VOUT_Cap = 0.1 μF, R_L = 10 Ω	114	122	134	μs
	Total Turn On Time	50% ON to 90% VOUT $V_{\text{IN}} = 3.3 \text{ V, VOUT_Cap} = 0.1 \ \mu\text{F,} \\ R_{\text{L}} = 10 \Omega$	146	156	176	μs
		50% ON to 90% VOUT V_{IN} = 1.5 V, VOUT_Cap = 0.1 μF, R_I = 10 Ω	292	332	399	μs

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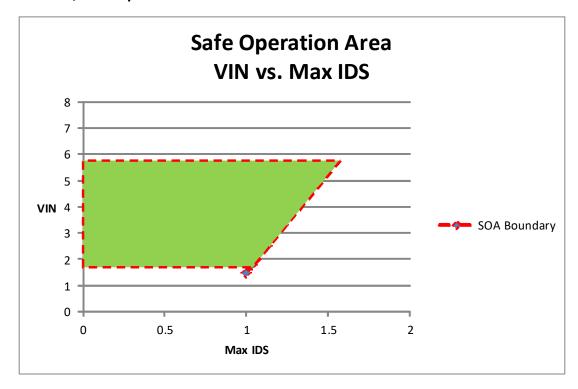
T_A = -40 °C to 85 °C (unless otherwise stated)

Parameter	Description	Conditions	Min.	Тур.	Max.	Unit
		10% VOUT to 90% VOUT V_{IN} = 5.0 V, VOUT_Cap = 0.1 μF, R_L = 10 Ω	92	97	107	μs
T _{RISE}	Rise Time	10% VOUT to 90% VOUT V_{IN} = 3.3 V, VOUT_Cap = 0.1 μ F, R_L = 10 Ω	116	120	131	μs
		10% VOUT to 90% VOUT V_{IN} = 1.5 V, VOUT_Cap = 0.1 μ F, R_L = 10 Ω	228	253	296	μs
R _{DIS}	Discharge Resistance	V _{IN} = 1.5 V to 5.5 V, V _{OUT} = 0.4 V Input Bias	65	80	400	Ω
ON_V _{IH}	Initial Turn On Voltage		0.85		V_{IN}	V
ON_V _{IL}	Low Input Voltage on ON pin		-0.3	0	0.3	V
T _{Delay_OFF}	OFF Delay Time	50% ON to V_{OUT} Fall, V_{IN} = 5 V, R_L =10 Ω , no C_L	6.2	6.5	7.0	μs

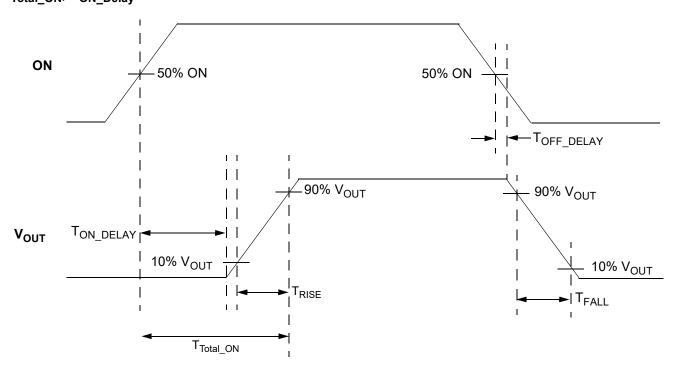
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VIN vs. Max IDS, Safe Operation Area



 $\mathbf{T}_{\text{Total_ON}}, \mathbf{T}_{\text{ON_Delay}}$ and Slew Rate Measurement



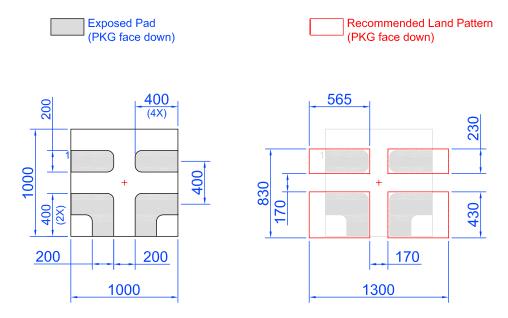
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SLG59M1557V Power-Up/Power-Down Sequence Considerations

A nominal power-up sequence is to apply VIN and toggle the ON pin LOW-to-HIGH after VIN is at least 90% of its final value. A nominal power-down sequence is the power-up sequence in reverse order. If VIN ramp is too fast, a voltage glitch may appear on the output pin at VOUT. To prevent glitches at the output, it is recommended to connect at least 0.1uF capacitor from the VOUT pin to GND and to keep the VIN ramp time less than 2 ms.

SLG59M1557V Layout Suggestion

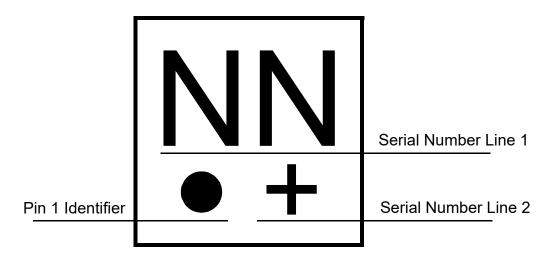


Note: All dimensions shown in micrometers (μm)

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Package Top Marking System Definition



NN -Part Serial Number Field Line 1 where each "N" character can be A-Z and 0-9

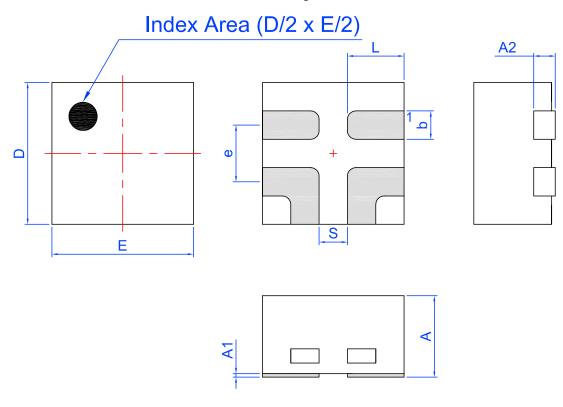
+ - Part Serial Number Field Line 2 where "+" character can be +, -, =, or blank

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Package Drawing and Dimensions

4 Lead STDFN Package 1.0 x 1.0 mm



Unit: mm

Symbol	Min	Nom.	Max	Symbol	Min	Nom.	Max
Α	0.50	0.55	0.60	D	0.95	1.00	1.05
A1	0.005	-	0.060	Е	0.95	1.00	1.05
A2	0.10	0.15	0.20	L	0.35	0.40	0.45
b	0.15	0.20	0.25	S	(0.2 REF	
е	(0.40 BSC	,				

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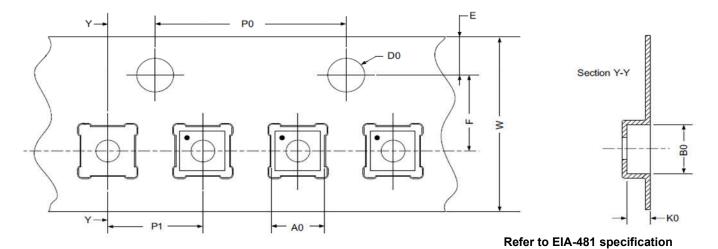


Tape and Reel Specifications

Bookogo	# of	Nominal Max Units		Reel &	Leader (min)		Trailer (min)		Tape	Part	
Package Type	# OI Pins	Package Size [mm]	per Reel	per Box	Hub Size [mm]	Pockets	Length [mm]	Pockets	Length [mm]	Width [mm]	Pitch [mm]
STDFN 4L 1x1mm 0.4P FC Green	4	1.0 x 1.0 x 0.55	8000	8000	178 / 60	200	400	200	400	8	2

Carrier Tape Drawing and Dimensions

Package Type	PocketBTM Length	PocketBTM Width	Pocket Depth	Index Hole Pitch	Pocket Pitch	Index Hole Diameter	Index Hole to Tape Edge		Tape Width
	A0	В0	K0	P0	P1	D0	E	F	W
STDFN 4L 1x1mm 0.4P FC Green		1.16	0.63	4	2	1.5	1.75	3.5	8



Recommended Reflow Soldering Profile

Please see IPC/JEDEC J-STD-020: latest revision for reflow profile based on package volume of 0.55 mm³ (nominal). More information can be found at www.jedec.org.

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Revision History

Date	Version	Change			
2/4/2022	1.04	Updated Company name and logo Fixed typos			
11/14/2017	1.03	Updated Package Marking Definition			
6/22/2016	Added section on Power Up/Down Sequence Considerations 6/22/2016 1.02 Added section on Power Up/Down Sequence Considerations Removed IDS_lkg parameter (same as IDD when OFF) Updated Recommended Layout suggestion				
9/11/2015	1.01	Updated IDD and Tdelay_ON			

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